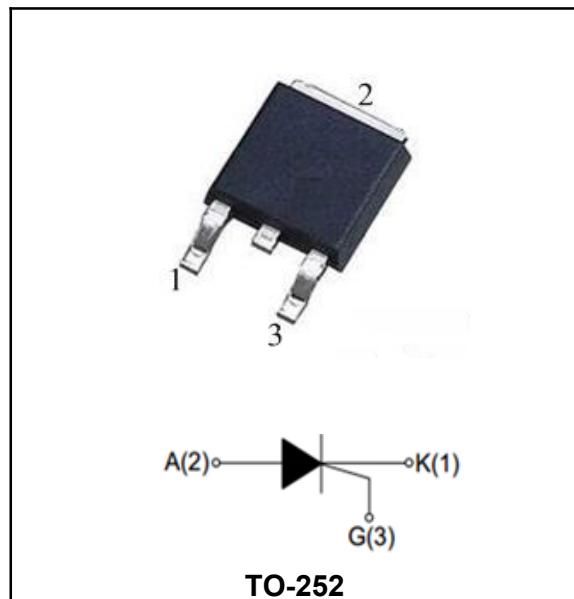


2A Standard SCR

Product Summary

| Symbol | Value | Unit |
|-------------------|---------|------|
| $I_{T(AV)}$ | 2 | A |
| $V_{DRM} V_{RRM}$ | 600/800 | V |
| V_{TM} | 1.55 | V |


Features

With high ability to withstand the shock loading of large current, Provide high dv/dt rate with strong resistance to electromagnetic interference

Application

Power charger, T-tools, massager, solid staterelay, AC Motor speed regulation and so on.

Order Information

| Part Number | Package | Marking | Packing | Packing Quantity |
|-------------|---------|-----------|---------|------------------|
| 2P4M | TO-252 | 2P4M XXXX | Tape | 3000PCS/Tape |

Absolute maximum ratings (Ta=25°C unless otherwise noted)

| Parameter | Symbol | Value | Unit |
|---|--------------|-----------|------------------|
| Repetitive peak off-state voltage | V_{DRM} | 600/800 | V |
| Repetitive peak reverse voltage | V_{RRM} | 600/800 | V |
| Average on-state current | $I_{T(AV)}$ | 2 | A |
| RMS on-state current | $I_{T(RMS)}$ | 3 | A |
| Non repetitive surge peak on-state current | I_{TSM} | 20 | A |
| I^2t value for fusing ($t_p=10ms$) | I^2t | 2 | A ² S |
| Critical rate of rise of on-state current | dI_T/dt | 50 | A/ μ s |
| Peak gate current ($t_p=20\mu s$, $T_j=110^\circ C$) | I_{GM} | 0.2 | A |
| Average gate power dissipation ($T_j=110^\circ C$) | P_G (AV) | 0.1 | W |
| Junction Temperature | T_j | -40~+110 | °C |
| Storage Temperature | T_{STG} | -40 ~+150 | °C |

Electrical characteristics (TA=25°C, unless otherwise noted)

| Parameter | Symbol | Test Condition | Value | | | Unit |
|--|-----------|---|-------|-----|-----|------------|
| | | | Min | Typ | Max | |
| Gate trigger current | I_{GT} | $V_D=6V, R_L=100\Omega, R_{GK}=1k\Omega$ | 10 | - | 200 | μA |
| Gate trigger voltage | V_{GT} | $V_D=12V, R_L=100\Omega, R_{GK}=1k\Omega$ | - | - | 0.8 | v |
| Gate non-trigger voltage | V_{GD} | $V_D=1/2V_{DRM}, R_{GK}=1k\Omega, T_j=110^\circ C$ | 0.2 | - | - | v |
| Holding current | I_H | $V_D=24V, R_{GK}=1k\Omega, I_{TM}=4A, T_j=25^\circ C$ | - | 1 | 3 | mA |
| latching current | I_L | $I_G=1.2I_{GT}$ | - | - | 4 | mA |
| Critical-rate of rise of commutation voltage | dV_D/dt | $V_D=2/3V_{DRM}, R_{GK}=1k\Omega, T_j=110^\circ C$ | 10 | - | - | V/ μs |

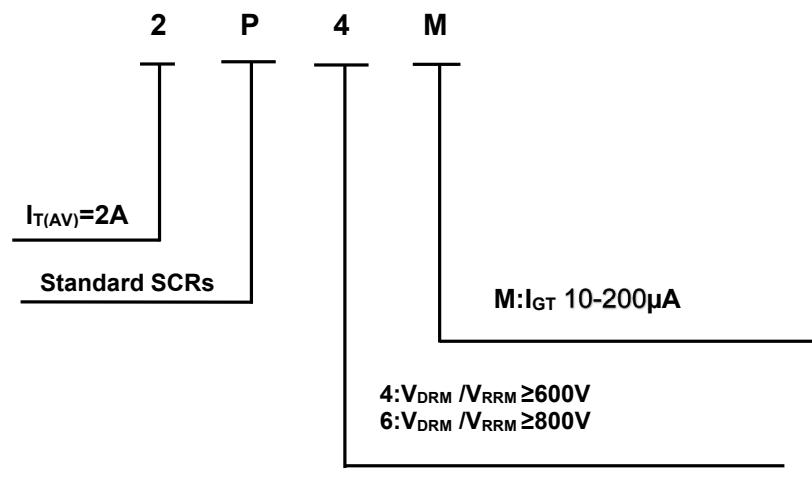
STATIC CHARACTERISTICS

| | | | | | | |
|-----------------------------------|-----------|--|---|---|------|---------|
| Forward "on" voltage | V_{TM} | $I_{TM}=4A$ | - | - | 1.55 | V |
| Repetitive Peak Off-State Current | I_{DRM} | $V_D=V_{DRM}/V_{RRM}, T_j=25^\circ C$ | - | - | 5 | μA |
| Repetitive Peak Reverse Current | I_{RRM} | $V_D=V_{DRM}/V_{RRM}, T_j=110^\circ C$ | - | - | 100 | μA |

THERMAL RESISTANCES

| | | | | | |
|--------------------|----------|---------------------|----------------------|------|--------------|
| Thermal resistance | Rth(j-c) | Junction to case | TYP. | 6.5 | $^\circ C/W$ |
| | Rth(j-a) | Junction to ambient | S=0.5cm ² | TYP. | 70 |

Ordering Information



Typical Characteristics

FIG.1: Maximum power dissipation versus RMS on-state current (full cycle)

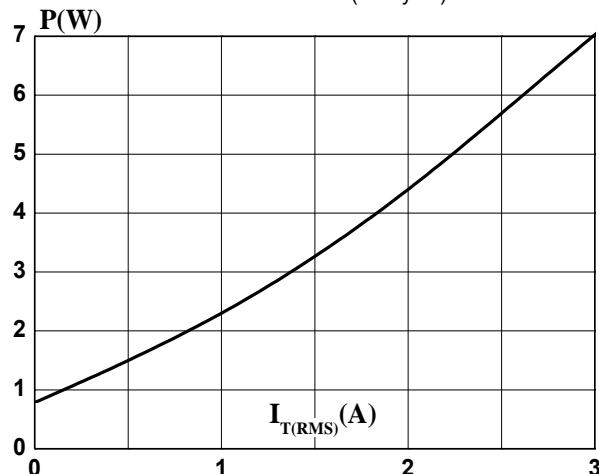


FIG.2: RMS on-state current versus case temperature (full cycle)

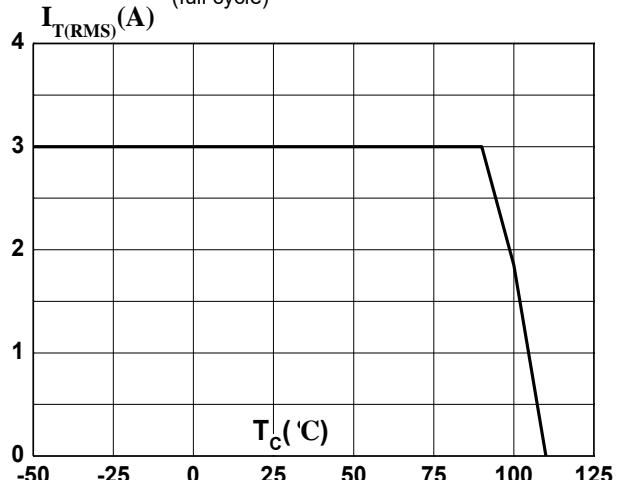


FIG.3: Surge peak on-state current versus number of cycles

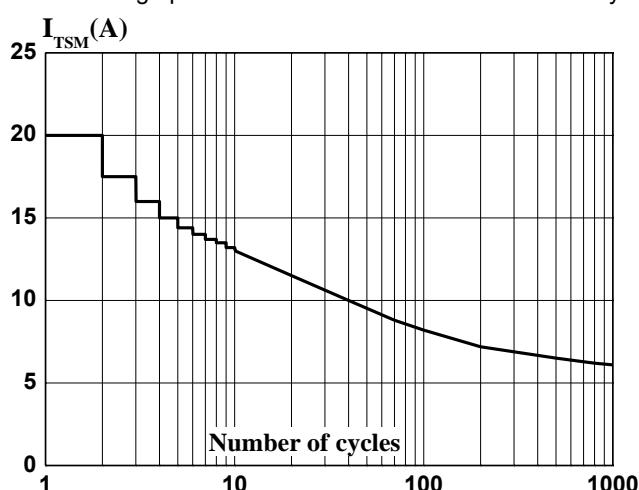


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10\text{ms}$

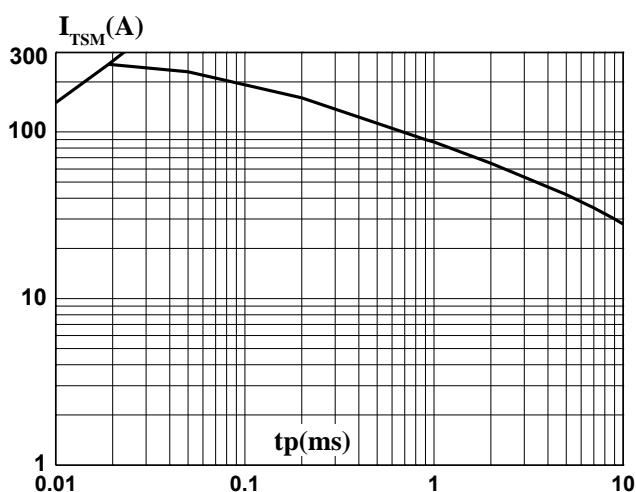


FIG.4: On-state characteristics (maximum values)

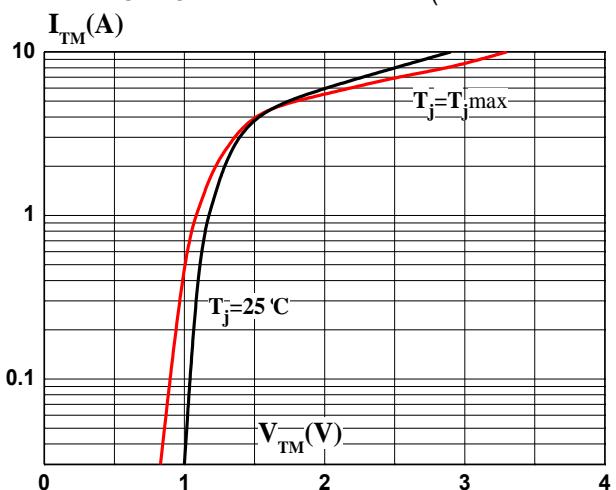
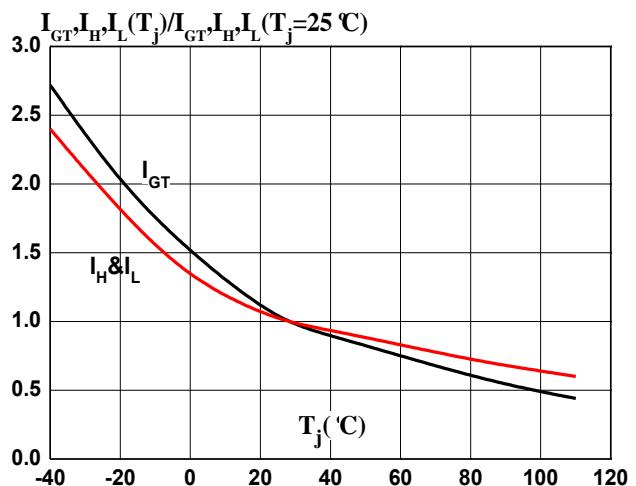


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature (typical values)



Package Information

TO-252

